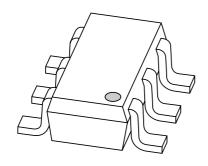
# **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# PMEM4010ND NPN transistor/Schottky diode module

Product data sheet Supersedes data of 2002 Oct 28



# NPN transistor/Schottky diode module

# PMEM4010ND

#### **FEATURES**

- 600 mW total power dissipation
- · High current capability
- Reduces required PCB area
- · Reduced pick and place costs
- Small plastic SMD package.

#### **Transistor:**

• Low collector-emitter saturation voltage.

## Diode:

- · Ultra high-speed switching
- · Very low forward voltage
- · Guard ring protected.

## **APPLICATIONS**

- DC/DC convertors
- · Inductive load drivers
- · General purpose load drivers
- Reverse polarity protection circuits.

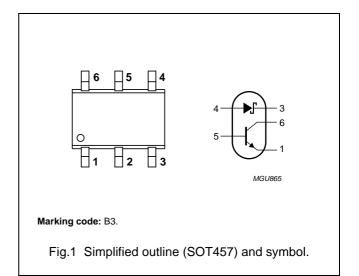
## **DESCRIPTION**

Combination of an NPN transistor with low  $V_{CEsat}$  and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.

PNP complement: PMEM4010PD.

#### **PINNING**

PIN	DESCRIPTION		
1	emitter		
2	not connected		
3	cathode		
4	anode		
5	base		
6	collector		



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#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
NPN trans	NPN transistor						
V <sub>CBO</sub>	collector-base voltage	open emitter	_	40	V		
V <sub>CEO</sub>	collector-emitter voltage	open base	_	40	V		
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V		
I <sub>C</sub>	collector current (DC)		_	1	А		
I <sub>CM</sub>	peak collector current		-	2	Α		
I <sub>BM</sub>	peak base current		-	1	А		
Tj	junction temperature		-	150	°C		
Schottky I	Schottky barrier diode						
$V_R$	continuous reverse voltage		_	20	V		
I <sub>F</sub>	continuous forward current		_	1	А		
I <sub>FSM</sub>	non repetitive peak forward current	t = 8.3 ms half sinewave; JEDEC method	-	5	A		
Tj	junction temperature		_	125	°C		
Combined device							
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	600	mW		
T <sub>stg</sub>	storage temperature		-65	+150	°C		
T <sub>amb</sub>	operating ambient temperature	note 2	-65	+125	°C		

# **Notes**

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.
- 2. For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are significant part of the total power losses. Nomograms for determination of the reverse power losses  $P_R$  and  $I_F$  (AV) rating will be available on request.

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; note 1	208	K/W

# Note

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.

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## **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
NPN transistor							
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 40 V; I <sub>E</sub> = 0	_	_	100	nA	
		V <sub>CB</sub> = 40 V; I <sub>E</sub> = 0; T <sub>amb</sub> = 150 °C	_	_	50	μΑ	
I <sub>CEO</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0	_	_	100	nA	
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA	
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 mA	300	_	_		
		V <sub>CE</sub> = 5 V; I <sub>C</sub> = 500 mA	300	_	900		
		V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 A	200	_	_		
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 100 mA; I <sub>B</sub> = 1 mA	_	_	80	mV	
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA	_	_	110	mV	
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	_	_	210	mV	
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	_	_	1.2	V	
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = 500 \text{ mA}$ ; $I_B = 50 \text{ mA}$ ; note 1	_	260	<220	mΩ	
$V_{BEon}$	base-emitter turn-on voltage	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 A	_	_	1.1	V	
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 50 mA; V <sub>CE</sub> = 10 V; f = 100 MHz	150	_	_	MHz	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ ; } f = 1 \text{ MHz}$	_	_	10	pF	
Schottky barrier diode							
V <sub>F</sub>	continuous forward voltage	I <sub>F</sub> = 10 mA; note 1	_	240	270	mV	
		I <sub>F</sub> = 100 mA; note 1	_	300	350	mV	
		I <sub>F</sub> = 1000 mA; see Fig.7; note 1	_	480	550	mV	
I <sub>R</sub>	reverse current	V <sub>R</sub> = 5 V; note 1	_	5	10	μА	
		V <sub>R</sub> = 8 V; note 1	_	7	20	μΑ	
		V <sub>R</sub> = 15 V; see Fig.8; note 1	-	10	50	μΑ	
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 5 V; f = 1 MHz; see Fig.9	_	19	25	pF	

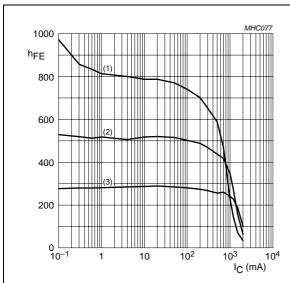
## Note

1. Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 

# NPN transistor/Schottky diode module

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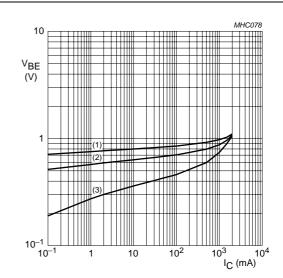
#### **GRAPHICAL DATA**



NPN transistor;  $V_{CE} = 5 \text{ V}.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

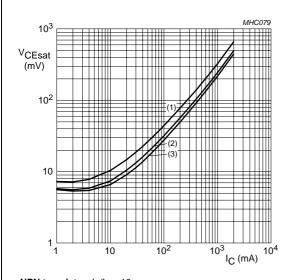
Fig.2 DC current gain as a function of collector current; typical values.



NPN transistor;  $V_{CE} = 5 V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

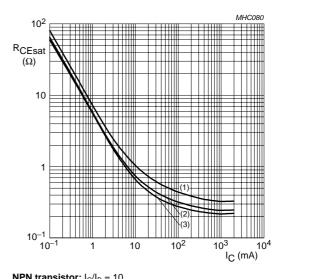
Base-emitter voltage as a function of collector current; typical values.



**NPN** transistor;  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



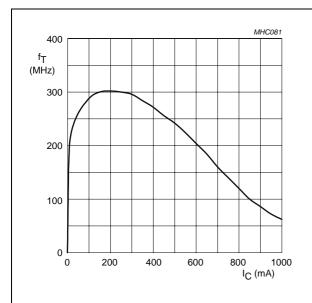
**NPN** transistor;  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

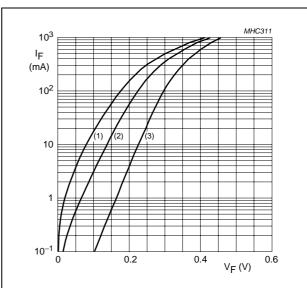
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NPN transistor;  $V_{CE} = 10 \text{ V}.$ 

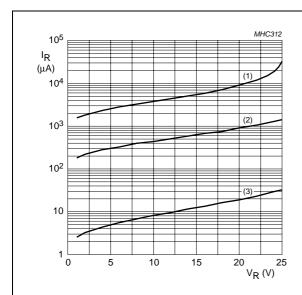
Fig.6 Transition frequency as a function of collector current.



Schottky barrier diode.

- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

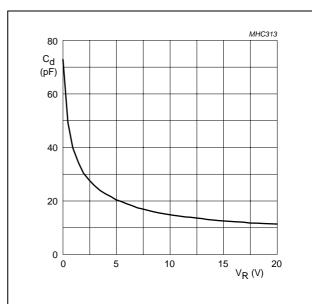
Fig.7 Forward current as a function of forward voltage; typical values.



## Schottky barrier diode.

- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

Fig.8 Reverse current as a function of reverse voltage; typical values.



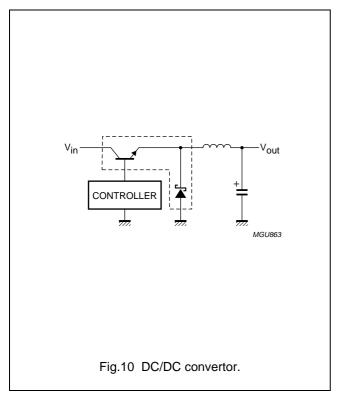
Schottky barrier diode; f = 1 MHz;  $T_{amb}$  = 25 °C.

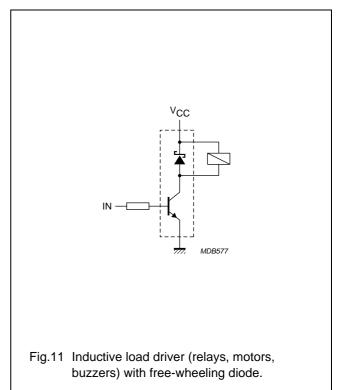
Fig.9 Diode capacitance as a function of reverse voltage; typical values.

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## **APPLICATION INFORMATION**





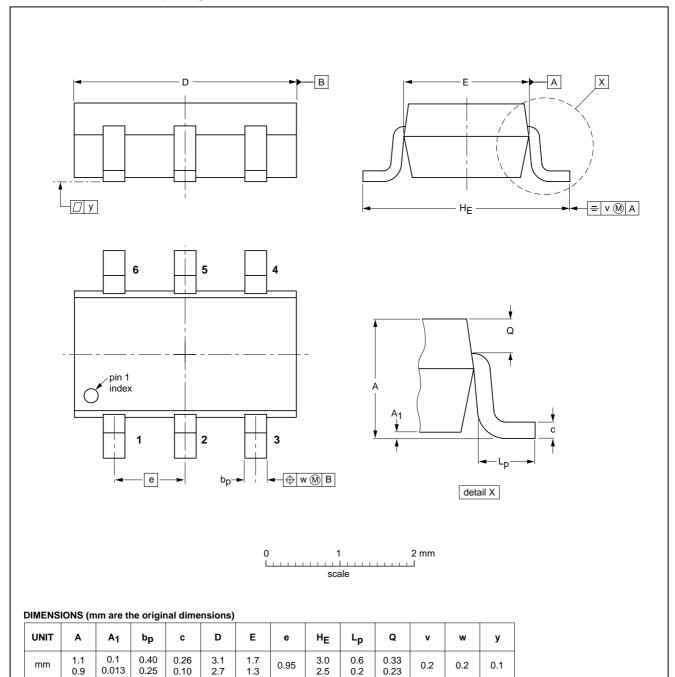
# NPN transistor/Schottky diode module

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## **PACKAGE OUTLINE**

Plastic surface mounted package; 6 leads

SOT457



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DATE	
SOT457			SC-74			<del>97-02-28</del> 01-05-04

# NPN transistor/Schottky diode module

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DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
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Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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